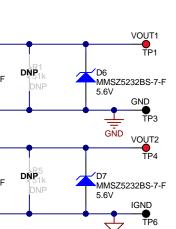
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3	TP2 47µH 47µH C3 10µF GND TP5	Image: Product of the second secon
В	TP5	GND 22.0M D5 R6 BAV21WS-7-F S1 S1 S1 S1 S1 S1 S1 S1 S1 S1
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	FID1	FID2 FID3
D	PCB F	Number: PMP20583 PCB Rev: A PCB LOGO FCC disclaimer Orderable: N/A Designed for: Public Release Mod. Date: 12/2/2017 TID#: PMP20583 Project Title: UCC28700-Q1 Dual Output Flyback Number: PMP20583 Number: PMP20583 Rev: A Sheet Title: Sheet Title: S do not warrant the accuracy or completeness of this specification or any information contained therein. Texas Instruments and/or its licensors do not SNRev: Version control disabed Assembly Variant: 001 Sheet: 1 of 1
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